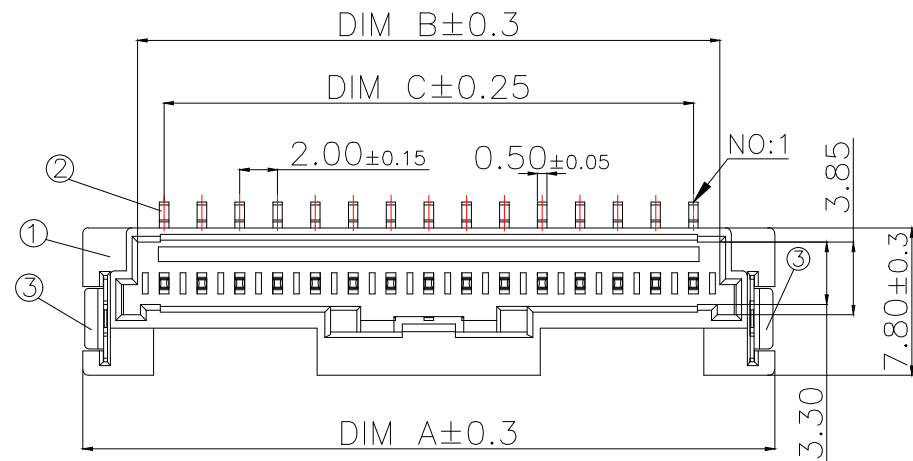
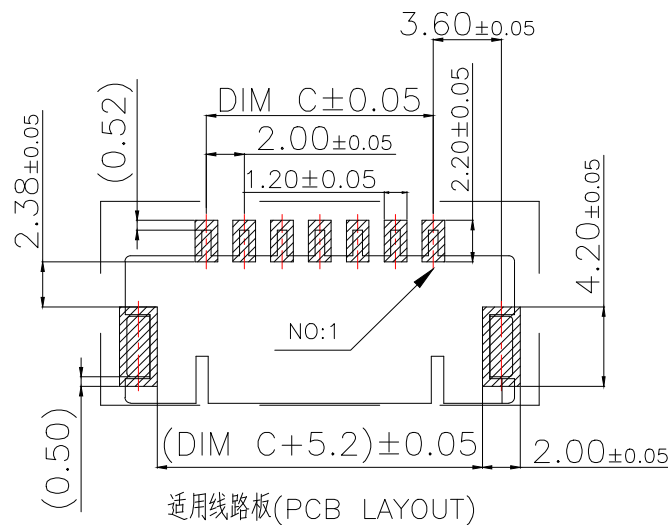


技术指标:

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
2. 温度范围: $-25^{\circ}\text{C} \sim 85^{\circ}\text{C}$.
3. 额定电压: 125V, AC/DC.
4. 额定电流: 2.0A AC DC(AWG#24, 0.D1.4mm MAX)
5. 接触电阻: $\leq 40\text{m}\Omega$.
6. 绝缘电阻: $\geq 1000\text{M}\Omega$.
7. 耐电压: 500V AC/Minute



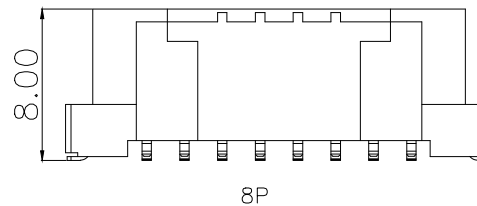
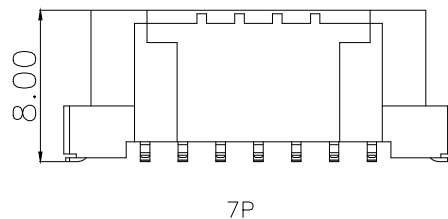
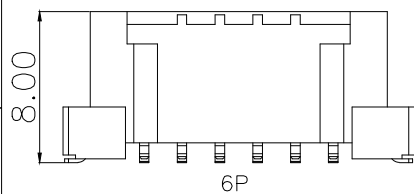
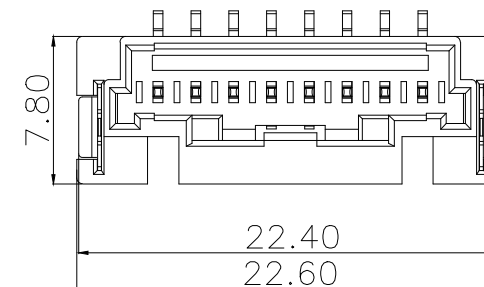
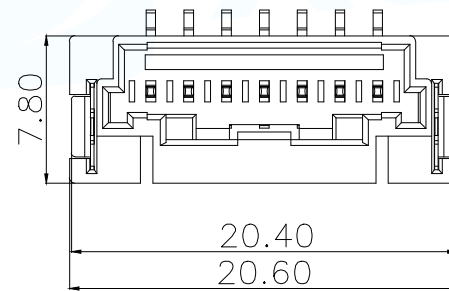
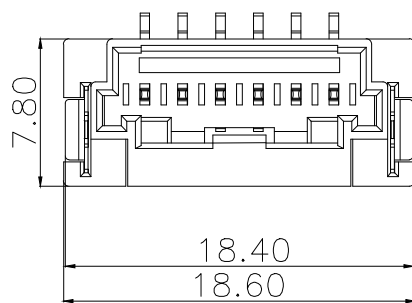
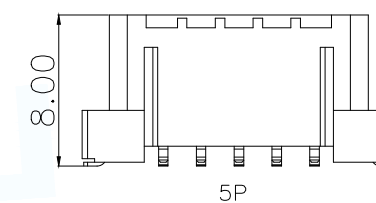
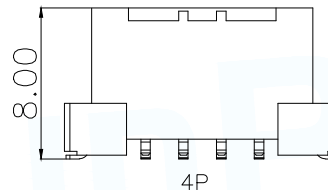
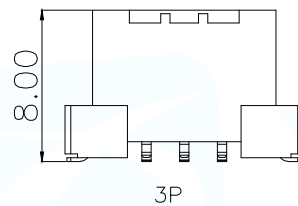
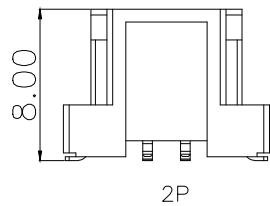
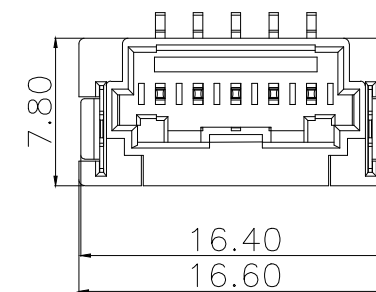
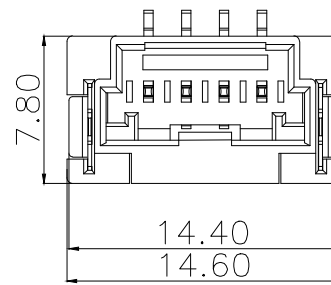
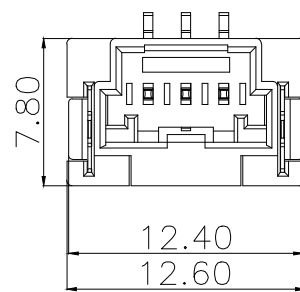
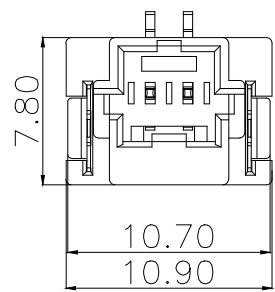
适用线路板(PCB LAYOUT)

MAPX	MODIFICATION	DATE	DRAW	APPROVE
序号 (NO.)	品名 (Name)	材质 (Material)		
①	MX2.0 Pitch B 型立式WTB嵌芯	PA9T UL94 V-0, 颜色:本色		
②	MX2.0 Pitch B 型立式WTB端子	铜合金/表面镀锡		
③	MX2.0 Pitch B 型立式WTB焊片	铜合金/表面镀锡		

P/N	PIN	DIM A	DIM B	DIM C
WAFER-MX2.0-2PLB	2	10.90	4.80	2.00
WAFER-MX2.0-3PLB	3	12.60	6.80	4.00
WAFER-MX2.0-4PLB	4	14.60	8.80	6.00
WAFER-MX2.0-5PLB	5	16.60	10.80	8.00
WAFER-MX2.0-6PLB	6	18.60	12.80	10.00
WAFER-MX2.0-7PLB	7	20.60	14.80	12.00
WAFER-MX2.0-8PLB	8	22.60	16.80	14.00
WAFER-MX2.0-9PLB	9	24.60	18.80	16.00
WAFER-MX2.0-10PLB	10	26.60	20.80	18.00
WAFER-MX2.0-11PLB	11	28.60	22.80	20.00
WAFER-MX2.0-12PLB	12	30.60	24.80	22.00
WAFER-MX2.0-13PLB	13	32.60	26.80	24.00
WAFER-MX2.0-14PLB	14	34.60	28.80	26.00
WAFER-MX2.0-15PLB	15	36.60	30.80	28.00
MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co., Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES		 TITLE: MX2.0 Pitch B型立式WTB业务图		
DECIMALS:		PAR		
X ± 0.15		WAFER-MX2.0-NPLB		
X ± 0.10		DWN		
XX ± 0.05		CHKD		
XXX ± 0.02		APVD		
ANGLES:		SCALE N:A		
X $\pm 1^{\circ}$		UNIT:MM		
		SIZE:A4		
		SHEET:1F1		
		REV:A		

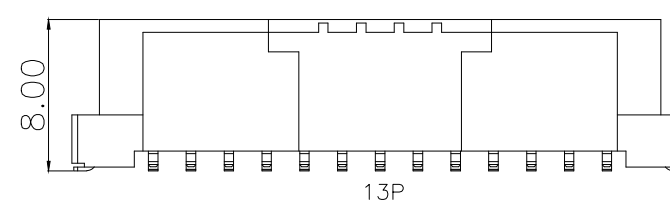
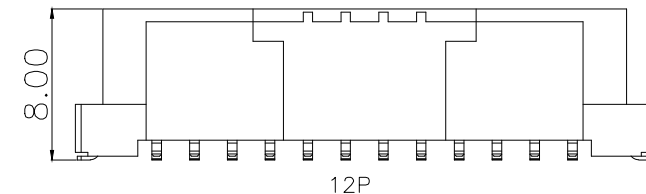
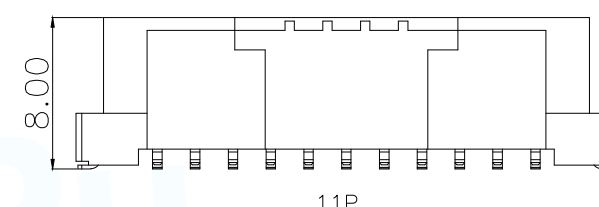
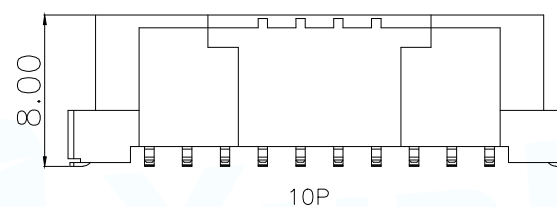
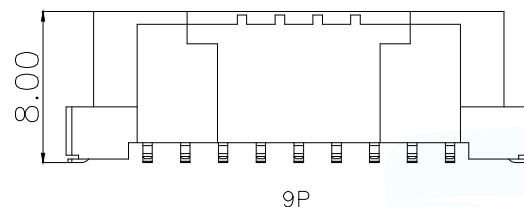
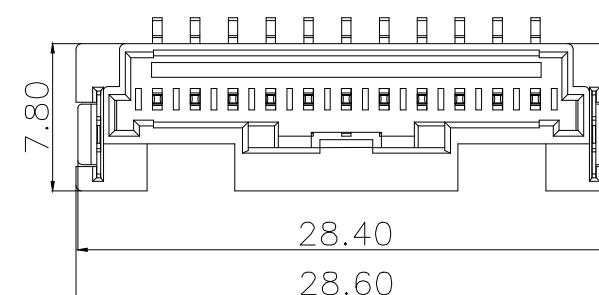
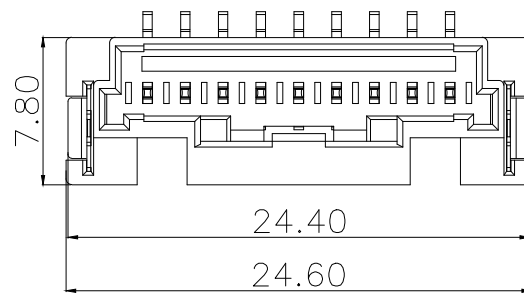
ROHS Compliant

MAPX	MODIFICATION	DATE	DRAW	APPROVE



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES				
DECIMALS:	ANGLES:			
X.±0.15				
.X ±0.10	±1°			
.XX ±0.05				
.XXX ±0.02		CUSTOMER COPY		
		TITLE: MX2.0 Pitch B型立式WTB业务图		
		PAR	WAFER-MX2.0-NPLB	
		DWN	Lucas	
		CHKD	Ethan	
		APVD	Jacob	
		SCALE N:A	UNIT:MM	
		SIZE:A4	SHEET:1F1	REV:A

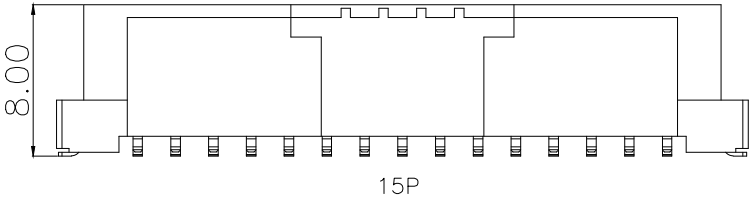
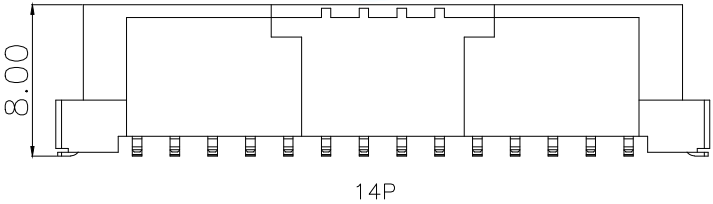
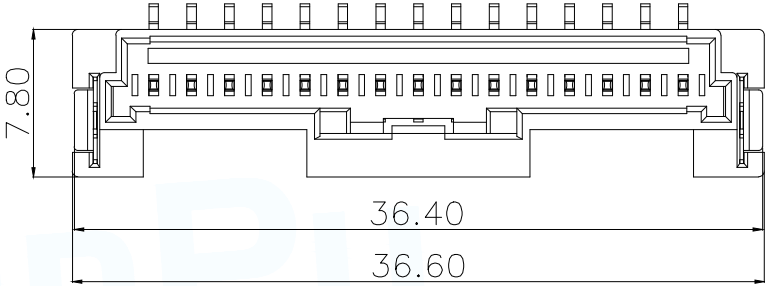
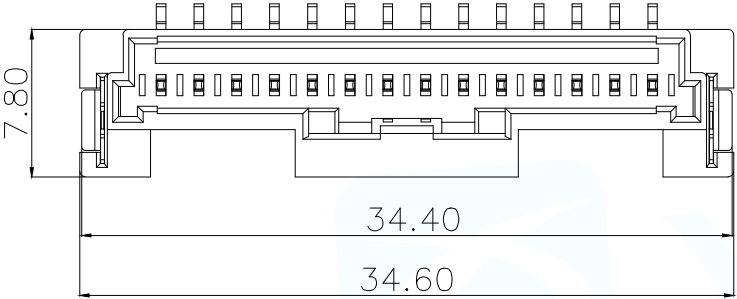
MAPX	MODIFICATION	DATE	DRAW	APPROVE



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES				
DECIMALS:	ANGLES:			
X.±0.15				
.X ±0.10	±1°			
.XX ±0.05				
.XXX ±0.02		CUSTOMER COPY		
		TITLE:	MX2.0 Pitch B型立式WTB业务图	
		PAR	WAFER-MX2.0-NPLB	
		DWN	Lucas	
		CHKD	Ethan	
		APVD	Jacob	
		SCALE N:A	UNIT:MM	
		SIZE:A4	SHEET:1F1	REV:A

ROHS Compliant

MAPX	MODIFICATION	DATE	DRAW	APPROVE



MANUFACTURE DWG

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:

X.±0.15

.X ±0.10

.XX ±0.05

.XXX ±0.02

ANGLES:

±1°

东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,Ltd

TITLE:
MX2.0 Pitch B型立式WTB业务图

PAR	WAFER-MX2.0-NPLB
DWN	Lucas
CHKD	Ethan
APVD	Jacob
SCALE N:A	UNIT:MM
CUSTOMER COPY	SIZE:A4
	SHEET:1F1
	REV:A